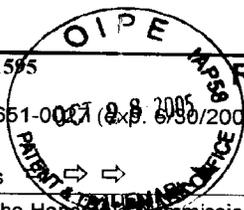


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To the Honorable Commissioner of Patents and Trademarks, U.S. Patent and Trademark Office, Washington, D.C. 20231. Enclosed original documents or copy thereof.

1. Name of conveying party(ies): Ghafour Benabdelaziz Laurent Gonthier. Additional name of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies) Name: STMicroelectronics SA Internal Address:

3. Nature of conveyance: Assignment Merger Security Agreement Change of Name Other. Execution Date: 9/16/2005

Street Address: 29, Boulevard Romain Rolland 92120 Montrouge, France City: State: Zip: Additional Name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No.(s) 11/138,655 B. Patent No.(s) Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning this document should be mailed: Name: Paul F. Rusyn Internal Address: Street Address: Graybeal Jackson Haley LLP 155 - 108th Avenue NE, Suite 350 City: Bellevue State: WA Zip: 98004

6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41) \$ 40 Enclosed Authorized to be charged to deposit account 8. Deposit account number: 07-1897 (Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Paul F. Rusyn Signature Date: October 26, 2005

Total number of pages including cover sheet, attachments, and documents: 2. Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

10.25.01

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|---------------------------------|-----------|
| (1) <u>BENABDELAZIZ Ghafour</u> | (4) _____ |
| (2) <u>GONTHIER Laurent</u> | (5) _____ |
| (3) _____ | (6) _____ |

who have made a certain new and useful invention, hereby sell, assign and transfer unto

STMicroelectronics SA
29, Boulevard Romain Rolland
92120 MONTROUGE, FRANCE

its successors and assign (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

CAPACITIVE POWER SUPPLY CIRCUIT AND METHOD

(a) for which an application for United States Letters Patent was filed on 11 AUGUST 2005, and identified by United States Serial No. 11/202,642; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

<u>INVENTORS</u>	<u>DATE SIGNED</u>
1) <u>BENABDELAZIZ Ghafour</u> Name: _____	<u>16/09/2005</u>
2) <u>GONTHIER Laurent</u> Name: _____	<u>16/09/2005</u>
3) _____ Name: _____	_____
4) _____ Name: _____	_____
5) _____ Name: _____	_____
6) _____ Name: _____	_____